

APPLICATION NO.

09/574,229

## United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

EXAMINER

FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. P19101 7775

7055 7590 04/20/2005 GREENBLUM & BERNSTEIN, P.L.C. 1950 ROLAND CLARKE PLACE RESTON, VA 20191

FILING DATE

05/19/2000

HECKENBERG JR, DONALD H ART UNIT PAPER NUMBER

1722

DATE MAILED: 04/20/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Toru Chiba

	Application No.	Applicant(s)	
Office Action Summary	09/574,229	CHIBA, TORU	
	Examiner	Art Unit	
	Donald Heckenberg	1722	
The MAILING DATE of this communication a Period for Reply	ippears on the cover sheet with	the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REF THE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a r  - If NO period for reply is specified above, the maximum statutory perions  - Failure to reply within the set or extended period for reply will, by state that the period for reply will, by state that the material patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a repl eply within the statutory minimum of thirty (; od will apply and will expire SIX (6) MONTH tute, cause the application to become ABAN	y be timely filed  30) days will be considered timely. IS from the mailing date of this communication. IDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on 21	January 2005.		
2a)⊠ This action is <b>FINAL</b> . 2b)□ TI	a)⊠ This action is <b>FINAL</b> . 2b)□ This action is non-final.		
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.			
Disposition of Claims	<b>,</b>		
4) ⊠ Claim(s) <u>1,2,4,5,21,23,27,28 and 30-35</u> is/and 4a) Of the above claim(s) is/are withd 5) □ Claim(s) is/are allowed.  6) ⊠ Claim(s) <u>1,2,4,5,21,23,27,28 and 30-35</u> is/and 7) □ Claim(s) is/are objected to.  8) □ Claim(s) are subject to restriction and	rawn from consideration. re rejected.		
Application Papers			
9) ☐ The specification is objected to by the Exami 10) ☑ The drawing(s) filed on 19 May 2000 is/are:  Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction.  The oath or declaration is objected to by the	a) accepted or b) objected or b) objected or b) objected he drawing(s) be held in abeyanced or between objection is required if the drawing(s)	e. See 37 CFR 1.85(a). is objected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for forei a) All b) Some * c) None of:  1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the priority docume application from the International Bure * See the attached detailed Office action for a li	ents have been received. ents have been received in Appriority documents have been re eau (PCT Rule 17.2(a)).	olication No eceived in this National Stage	
Attachment(s)			
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/0 Paper No(s)/Mail Date		Mail Date wmal Patent Application (PTO-152)	

1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. The factual inquiries set forth in <u>Graham v. John Deere</u>

  <u>Co.</u>, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
  - 1. Determining the scope and contents of the prior art.
  - 2. Ascertaining the differences between the prior art and the claims at issue.
  - 3. Resolving the level of ordinary skill in the pertinent art.
  - 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.
- 3. Claims 1, 2, 21, 23, 27, 28, and 33-35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Neefe (U.S. Pat. No. 4,416,837; previously of record) in view of Wichterle (U.S. Pat. No. 3,660,545).

Neefe discloses a lens molding die for spin casting of contact lenses. The die comprises a base member (2) made of a hard metal material (see Fig. 1 and cl. 1, ll. 50-51). The base

Art Unit: 1722

member has a spherically shaped surface (3). A resin-molded surface layer is formed on the spherical surface of the base member (see Fig. 2 and cl. 1, ll. 55-65). The resin molded surface layer is provided with an aspheric surface shape corresponding to the shape of the lens to be produced (Figs. 2-The surface shape of the resin molded surface layer is uninterrupted- that is smooth with no notches or other discontinuous structures (see Fig. 2). The aspheric surface layer, while conforming to the spherically shaped surface of the base member, has a different curvature than the curvature of the spherically shaped surface of the base member (Fig. 2). thickness of the resin-molded surface layer is less than the thickness of the base member (Fig. 2), and the resin-molded surface layer is as such to be inactive with a material to be molded by the lens molding die (see cl. 1, 1. 67 - cl. 2, 1. 8, noting that cross-linking agents are used to prevent the lens from sticking to the surface of the resin-molded layer, thus in effect making the resin molded surface and the lens molding material inactive with each other). As shown in Fig. 2, the thickness of the resin-molded surface layer is configured to vary only in accordance with the aspheric component of the resin-molded surface layer.

While Neefe notes that the disclosed structure is for spin casting lenses, the reference does not disclose any additional apparatus structures. Thus, Neefe does not disclose a cylindrical holder configured to surround and hold the base member, nor a ring-shaped positioning member configured to coaxially engage the cylindrical holder.

Wichterle discloses an apparatus for centrifugally (spin) casting contact lenses. The apparatus includes a base member (1) which provides the molding surface. The apparatus further comprises a cylindrical holder (2) configured to surround and securely hold the base member during the casting operation (see Figs. 1-2 and cl. 3, 11. 48-53). Wichterle further discloses a ring-shaped positioning member (4) configured to coaxially engage the cylindrical holder to cap the base mold member (1) and provide part of a mechanism for supplying molding material to the mold (see Figs. 1-2; cl. 3, 11. 54-64; and cl. 4, 11. 58-71).

It would have been obvious to one of ordinary skill in the art at the time of Applicant's invention to have modified the apparatus disclosed by Neefe as such to used a cylindrical holder configured to surround and securely hold the base member because this would allow for the mold to be spun during the casting operation as suggested by Wichterle. It further would

have been obvious to one of ordinary skill in the art at the time of Applicant's invention to have further included a ring-shaped positioning member configured to coaxially engage the cylindrical holder because this would provide a cap for the base member and can be provide part of a mechanism for supplying molding material to the mold as suggested by Wichterle.

4. Claims 4 and 5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Neefe modified by Wichterle as applied to claims 1, 2, 21, 23, 27, 28, and 33-35 above, and further in view of Blum (U.S. Pat. No. 5,141,678; previously of record).

Neefe and Wichterle disclose and suggest the lens mold as described above, notably including the use of a resin molded surface layer. However, Neefe and Wichterle do not disclose the type of resin molded surface layer used.

Blum discloses a lens molding die provided with a resin molded surface layer (12). Blum notes that such a surface layer may alternatively be made from thermosetting or ultraviolet curable resins (cl. 3, ll. 41-42 and cl. 4, ll. 4-13).

It would have been obvious to one of ordinary skill in the art at the time of Applicant's invention to have used either a thermosetting or ultraviolet curable resin to form the resin molded surface layer disclosed and suggested by Neefe and

Wichterle because these are two types of resins known in the art as suitable to form such lens mold layer as suggested by Blum.

5. Claims 30-32 are rejected under 35 U.S.C. 103(a) as being unpatentable over Neefe modified by Wichterle as applied to claims 1, 2, 21, 23, 27, 28, and 33-35 above, and further in view of Ishihara et al. (U.S. Pat. No. 6,315,929; previously of record).

Neefe and Wichterle disclose and suggest the lens molding die as described above, notably including the use of a resin molded surface layer. However, Neefe and Wichterle do not disclose the thickness of the resin molded surface layer.

Ishihara discloses a lens molding die. The lens molding die is provided with a resinous surface layer (10). Ishihara notes the surface layer should be in the range of 0.1 - 10 mm thick for assuring high molding efficiency (cl. 6, ll. 22-33).

It would have been obvious to one of ordinary skill in the art at the time of Applicant's invention to have made the resin molded surface layer of Neefe and Rawlings 0.1 - 10 mm thick because such a thickness allows for high molding efficiency as suggested by Ishihara. Note, the range of 0.1 - 10 mm fully encompasses, and thus anticipates, the claimed range of 0.2 to 0.5 mm recited in the instant application. Note further, this

Application/Control Number: 09/574,229
Art Unit: 1722

modification of the die disclosed and suggested by Neefe,
Wichterle, and Ishihara amounts to the optimization of a
property of the apparatus- the thickness of the resin molded
surface layer. Generally, the optimization of a known cause
effective variable such as the thickness of the resin surface
layer is seen as obvious to one of ordinary skill in the art. In
re Boesch, 617 F.2d 272, 205 USPQ 215 (CCPA 1980); In re Aller,
220 F.2d 454, 105 USPQ 233 (CCPA 1955).

- 6. Applicant's arguments with respect to claims 1, 21, and 23 have been considered but are moot in view of the new grounds of rejection.
- 7. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, <u>THIS ACTION IS MADE FINAL</u>. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened

Art Unit: 1722

statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Donald Heckenberg whose telephone number is (571) 272-1131. The examiner can normally be reached on Monday through Friday from 9:30 A.M. to 6:00 P.M.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Benjamin Utech, can be reached at (571) 272-1137. The official fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system,

Application/Control Number: 09/574,229 Page 9

Art Unit: 1722

see <<http://pair-direct.uspto.gov>>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at (866) 217-9197 (toll-free).

Donald Heckenberg

Patent Examiner

A.U. 1722